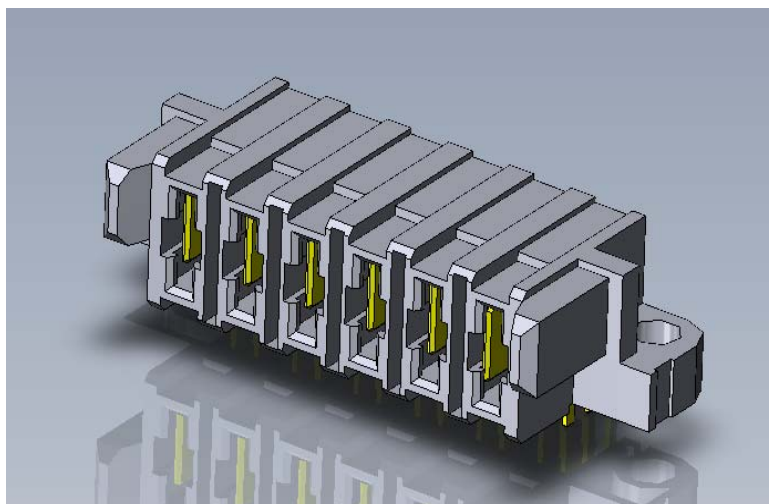




Project Number: Design Verification Test Report		Tracking Code: 099830_Report_Rev_1	
Requested by: Adam owens		Date: 10/6/2010	Product Rev: A
Part #: MPS-08-01-L-RA-SD\MPT-08-01-T-RA-SD		Lot #: 6/10/2010	Tech: Aaron McKim   Eng: Eric Mings
Part description: MPS			Qty to test: 6
Test Start: 8/30/2010	Test Completed: 9/25/2010		



**Design Verification Test Report**  
**MPS**  
**MPS-08-01-L-RA-SD\MPT-08-01-T-RA-SD**

Tracking Code: 099830_Report_Rev_1	Part #: MPS-08-01-L-RA-SD\MPT-08-01-T-RA-SD
Part description: MPS	

## CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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### SCOPE

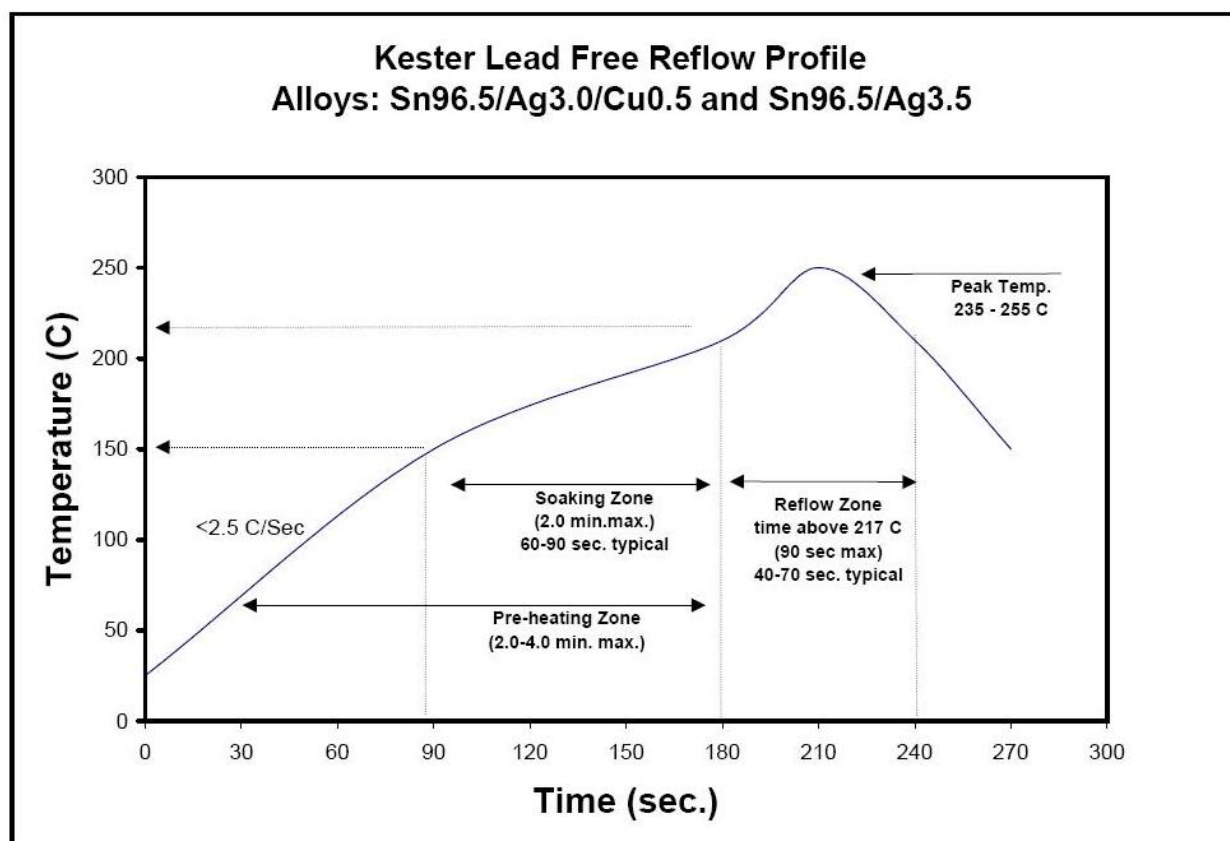
To perform the following tests: test per the "MPS IR\_DWV" test plan.

### APPLICABLE DOCUMENTS

Standards: EIA Publication 364

### TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR and DWV/IR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR and DWV/IR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead free
- 9) Re-Flow Time/Temp: See accompanying profile.
- 10) Samtec Test PCBs used: PCB-102159-TST-XX

**TYPICAL OVEN PROFILE (Soldering Parts to Test Boards)**

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Part description: MPS	

# FLOWCHARTS

## IR & DWV

TEST STEP	GRO UP A1 2 Mated Sets Break Down - Pin to Pin	GROUP A2 2 Unmated of Part # Being Tested Break Down - Pin to Pin	GRO UP A3 2 Unmated of Mating Part # Break Down - Pin to Pin	GRO UP B 2 Mated Sets Pin to Pin
01	DW V/Break Down Voltage	DWV/Break Down Voltage	DW V/Break Down Voltage	IR & DW V at test voltage (on both mated sets and on each connector unmated)
02				Thermal Aging (both sets unmated)
03				IR & DW V at test voltage (on both mated sets and on each connector unmated)
04				Cyclic Humidity (both sets unmated)
05				IR & DW V at test voltage (on both mated sets and on each connector unmated)

\* - DWV on group B to be performed at Test Voltage  
DWV test voltage is equal to 75% of the lowest break down voltage from group A1, A2 or A3  
Thermal Aging = EIA-364-17, Test Condition 4 (105 °C)  
Time Condition 'B' (250 hours)  
Humidity = EIA-364-31, Test Condition B (240 Hours)  
and Method III (+25° C to +65° C @ 90% RH to 98% RH)  
ambient pre-condition and delete steps 7a and 7b  
IR = EIA-364-21  
DWV = EIA-364-20, Test Condition 1

**ATTRIBUTE DEFINITIONS**

The following is a brief, simplified description of attributes.

**INSULATION RESISTANCE (IR):**

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

**1) PROCEDURE:**

- a. Reference document: EIA-364-21, *Insulation Resistance Test Procedure for Electrical Connectors*.
- b. Test Conditions:
  - i. Between Adjacent Contacts or Signal-to-Ground
  - ii. Electrification Time 2.0 minutes
  - iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.

**2) MEASUREMENTS:**

- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

**DIELECTRIC WITHSTANDING VOLTAGE (DWV):**

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

**1) PROCEDURE:**

- a. Reference document: EIA-364-20, *Withstanding Voltage Test Procedure for Electrical Connectors*.
- b. Test Conditions:
  - i. Between Adjacent Contacts or Signal-to-Ground
  - ii. Rate of Application 500 V/Sec
  - iii. Test Voltage (VAC) until breakdown occurs

**2) MEASUREMENTS/CALCULATIONS**

- a. The breakdown voltage shall be measured and recorded.
- b. The dielectric withstanding voltage shall be recorded as 75% of the minimum breakdown voltage.
- c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

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Part description: MPS	

### RESULTS

#### Insulation Resistance minimums, IR

- **Initial**
  - Mated----- 100000Meg  $\Omega$  ----- Pass
  - Unmated ----- 100000Meg  $\Omega$  ----- Pass
- **Thermal**
  - Mated----- 50000Meg  $\Omega$  ----- Pass
  - Unmated ----- 50000Meg  $\Omega$  ----- Pass
- **Humidity**
  - Mated----- 25000Meg  $\Omega$  ----- Pass
  - Unmated ----- 50000Meg  $\Omega$  ----- Pass

#### Dielectric Withstanding Voltage minimums, DWV

- **Minimums**
  - Breakdown Voltage----- 2300 VAC
  - Test Voltage ----- 1725 VAC
  - Working Voltage ----- 575 VAC
- **Initial DWV** ----- Passed
- **Thermal DWV** ----- Passed
- **Humidity DWV** ----- Passed

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Part description: MPS	

### DATA SUMMARIES

#### INSULATION RESISTANCE (IR):

	Pin to Pin		
	Mated	Unmated	Unmated
Minimum	MPS/MST	MPS	MPT
Initial	100000	100000	100000
Thermal	50000	50000	50000
Humidity	25000	100000	50000

#### DIELECTRIC WITHSTANDING VOLTAGE (DWV):

Voltage Rating Summary	
Minimum	MPS/MPT
Breakdown Voltage	2300
Test Voltage	1725
Working Voltage	575

Pin to Pin	
Initial Test Voltage	Passed
After Thermal Test Voltage	Passed
After Humidity Test Voltage	Passed

**DATA****INSULATION RESISTANCE (IR):****Initial Insulation Resistance****Measured In Meg Ohms**

Pin to Pin			
	Mated	A Unmated	B
	X	X	X
Sample#	MPS/MPT	MPS	MPT
099830-005	100000	100000	100000
099830-006	100000	100000	100000

**Thermal Insulation Resistance****Measured In Meg Ohms**

Pin to Pin			
	Mated	A Unmated	B
	X	X	X
Sample#	MPS/MPT	MPS	MPT
099830-005	50000	50000	50000
099830-006	50000	50000	50000

**Humidity Insulation Resistance****Measured In Meg Ohms**

Pin to Pin			
	Mated	A Unmated	B
	X	X	X
Sample#	MPS/MPT	MPS	MPT
099830-005	25000	100000	50000
099830-006	50000	100000	50000



**DATA Continued****DIELECTRIC WITHSTANDING VOLTAGE (DWV):**

Initial Breakdown Voltage	
Test Voltage <i>Until Breakdown Occurs</i>	

Pin to Pin			
Mated		A	Unmated B
X			
Sample#	MPS/MPT	MPS	MPT
099830-001	2900	2900	2900
099830-002	2300	2700	2700

Initial DWV	
Test Voltage= 1725	

Pin to Pin			
Mated		A	Unmated B
Sample#	MPS/MPT	MPS	MPT
099830-005	1725	1725	1725
099830-006	1725	1725	1725

Thermal Test Voltage	
Test Voltage=1725	

Pin to Pin			
Mated		A	Unmated B
Sample#	MPS/MPT	MPS	MPT
099830-005	1725	1725	1725
099830-006	1725	1725	1725

Humidity Test Voltage	
Test Voltage=1725	

Pin to Pin			
Mated		A	Unmated B
Sample#	MPS/MPT	MPS	MPT
099830-005	1725	1725	1725
099830-006	1725	1725	1725

Tracking Code: 099830_Report_Rev_1	Part #: MPS-08-01-L-RA-SD\MPT-08-01-T-RA-SD
Part description: MPS	

## EQUIPMENT AND CALIBRATION SCHEDULES

**Equipment #:** HPM-01

**Description:** Hipot Megommeter

**Manufacturer:** Hipotronics

**Model:** H306B-A

**Serial #:** M9905004

**Accuracy:** 2 % Full Scale Accuracy

... Last Cal: 11/30/2009, Next Cal: 11/30/2010